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## **ADVANCED COMMUNICATIONS & SENSING**

#### GENERAL DESCRIPTION

The SX8677 and SX8678 belong to a family of high performance haptics enabled multitouch 4/5-wire resistive touch screen controller with proximity detection, optimized for hand held applications such as mobile phones, portable music players, game machines, point-of-sales terminal and other consumer and industrial applications. They feature a wide input supply range from 2.3V to 3.6V.

EMTECH

The controller computes touch screen X-Y coordinates and touch pressure with a precision, low power 12-bit analog-digital converter. On-chip data averaging processing algorithms can be activated to reduce host activity and suppress system noise. The processing core features low power modes which intelligently minimize current in operation as well as in automatic shut-down.

Multitouch feature enables detection of 2 fingers on the touchscreen and several gestures like rotation and pinch/stretch.

A capacitive proximity detection circuit has been integrated into the SX8677 to enable host controlled power management for battery applications. Proximity detection above 5 cm is possible using either the resistive touch screen as the sensor or with a single conductive plate, with communication to the host via the serial interface.

The SX8677 and SX8678 also integrate a haptics motor driver for Linear Resonant Actuator (LRA) and Eccentric Rotating Mass (ERM) micro motors with up to 250mA drive current. Haptics control can be performed using either an external PWM signal or the I2C serial interface, providing simple host interfacing and minimizing its I/O requirement. The SX8677/78 supports Immersion TouchSense® 3000 haptic control software for high quality touch feedback.

Integrated very high ESD protection, of up to  $\pm 15 \text{kV}$  on display inputs not only saves cost and board area, but also increases application reliability.

The three devices have an ambient operating temperature range of -40 °C to +85 °C, and are offere d in both a 4mm x 4mm, 20-lead QFN package and 2.07mm x 2.07mm 19-lead CSP package for space-conscious applications.

#### **TYPICAL APPLICATIONS**

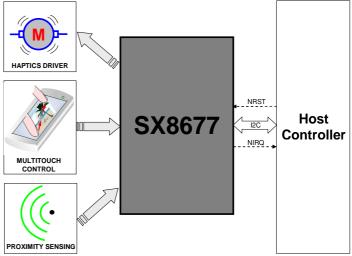
- Game Machines, Portable Music Players
- Mobile Phones
- DSC, DVR, Phones
- POS/POI Terminals
- Touch-Screen Monitors

#### ORDERING INFORMATION

Part Number	Package	Marking		
SX8677IWLTRT	QFN-20	BNT2		
SX8677ICSTRT	WLCSP-19			
SX8678IWLTRT	QFN-20	RP9X		
SX8678ICSTRT	WLCSP-19	nr9A		
SX8674EVK	Evaluation Kit	-		

#### **KEY PRODUCT FEATURES**

- Low Voltage Operation
  - 2.3V to 3.6V Supply
  - Integrated Low Drop Out (LDO) Regulator
- Low Power Consumption
  - 30uA@2.3V 8ksps (ESR)
  - 0.4uA Shut-Down Current
- 4/5-Wire Touchscreen Interface
  - Precision, Ratiometric 12-bit ADC
  - Up to 5000 (X-Y) coordinates/second (c/s)
  - Programmable Digital Filtering/Averaging
  - Touch Pressure Measurement (4-Wire)
  - Programmable Operating Mode (Manual, Pen Detect, Pen Trigger)
- Capacitive Proximity Sensing (SX8677)
  - No Additional Components Required
  - Uses Resistive Touchscreen or a Simple Conductive Area as the Sensor
  - >5 cm Detection Distance
  - 8uA @ 200ms Scan Period
  - Fully Programmable (Sensitivity, etc)
- Haptics Driver for LRA and ERM (SX8677/78)
  - Supports Immersion TouchSense® 3000 haptic control software
  - Haptics Waveform Generation Control (I2C or PWM Input)
  - Short Circuit Protection
  - Early Warning and Over-Temperature Monitoring and Protection
- 400kHz I2C Serial Interface
- Several Host Operating Modes Available
  - Maskable Interrupt Output (NIRQ)
  - Real-time Events Monitoring (AUX1-3)
  - Polling (I2C)
- Hardware, Software, and Power-On Reset
- -40°C to +85°C Operating Temperature Range
- 15kV HBM & IEC ESD Protection
- Small Footprint Packages
- Pb & Halogen Free, RoHS/WEEE compliant





Haptics Enabled Multitouch 4/5-Wire Resistive Touchscreen Controller with Proximity Sensing

## ADVANCED COMMUNICATIONS & SENSING

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Haptics Enabled Multitouch 4/5-Wire Resistive Touchscreen Controller with Proximity Sensing

## ADVANCED COMMUNICATIONS & SENSING

#### 1 GENERAL DESCRIPTION

1.1 Marking Information

<u>1.1.1</u> SX8677

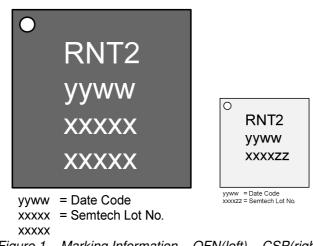
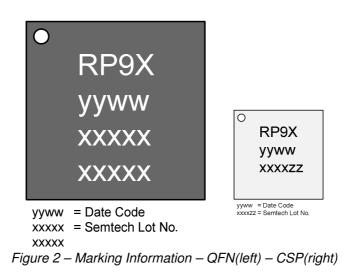


Figure 1 – Marking Information – QFN(left) – CSP(right)

<u>1.1.2</u> SX8678





Haptics Enabled Multitouch 4/5-Wire Resistive Touchscreen Controller with Proximity Sensing

### ADVANCED COMMUNICATIONS & SENSING

#### 1.2 Pin Diagrams

1.2.1 QFN Package

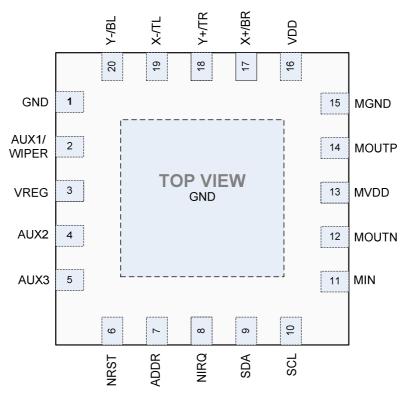
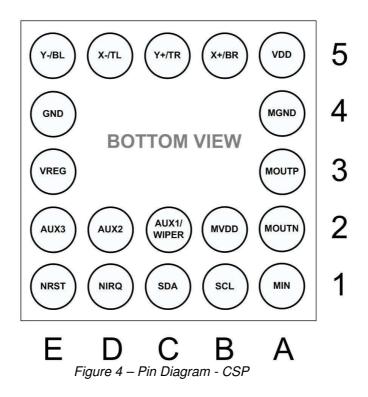


Figure 3 – Pin Diagram – QFN

#### 1.2.2 CSP Package



SEMTECH

## SX8677/SX8678

Haptics Enabled Multitouch 4/5-Wire Resistive Touchscreen Controller with Proximity Sensing

## **ADVANCED COMMUNICATIONS & SENSING**

### 1.3 Pin Description

	_	
Name	Туре	Description
VDD	Р	Main Power Supply
GND	Р	Main Ground
VREG	Р	Internal Regulator Output (must be connected to an external capacitor; see §13)
MVDD	Р	Haptics Motor Power Supply
MGND	Р	Haptics Motor Ground (must be electrically connected to GND)
MOUTP	AO	Haptics Motor Positive Drive
MOUTN	AO	Haptics Motor Negative Drive
MIN	DI	Haptics Motor PWM/Clock Input
X+/BR	А	<ul> <li>4-wire Touchscreen : X+ Electrode</li> </ul>
Λ+/DΠ	A	<ul> <li>5-wire Touchscreen : Bottom Right (BR) Electrode</li> </ul>
	۸	<ul> <li>4-wire Touchscreen : Y+ Electrode</li> </ul>
Y+/TR A		<ul> <li>5-wire Touchscreen : Top Right (TR) Electrode</li> </ul>
	^	4-wire Touchscreen : X- Electrode
X-/TL	A	<ul> <li>5-wire Touchscreen : Top Left (TL) Electrode</li> </ul>
	•	4-wire Touchscreen : Y- Electrode
Y-/BL	A	<ul> <li>5-wire Touchscreen : Bottom Left (BL) Electrode</li> </ul>
		• 4-wire Touchscreen : First Programmable Auxiliary Function (see §9)
AUX1/WIPER	D/A	• 5-wire Touchscreen : WIPER Electrode
AUX2	D/A	Second Programmable Auxiliary Function (see §9)
AUX3	D/A	Third Programmable Auxiliary Function (see §9)
ADDR	DI	I2C Address Selection (QFN only, internally connected to GND on CSP)
SCL	DI	I2C Clock Input
SDA	DIO	I2C Data Input/Output
NIRQ	DO	Interrupt Output (active low)
NRST	DI	Reset Input (active low)
	Analog/Dic	ital/Power/Input/Output

A/D/I/O/P: Analog/Digital/Power/Input/Output

Table 1 – Pin Description

#### 1.4 Block Diagram

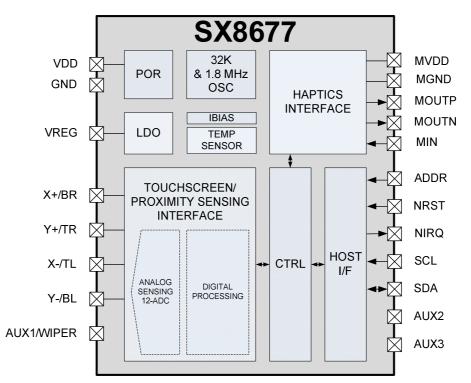


Figure 5 – SX8677 Block Diagram



Haptics Enabled Multitouch 4/5-Wire Resistive Touchscreen Controller with Proximity Sensing

### ADVANCED COMMUNICATIONS & SENSING

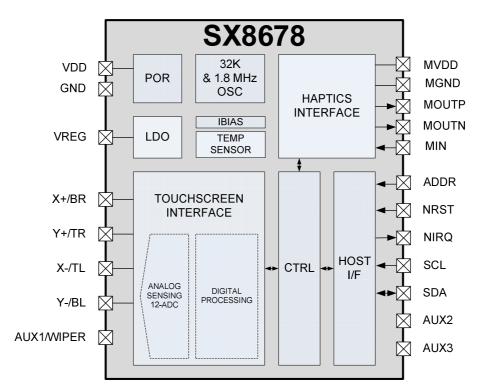


Figure 6 – SX8678 Block Diagram



## ADVANCED COMMUNICATIONS & SENSING

#### 2 ELECTRICAL CHARACTERISTICS

#### 2.1 Absolute Maximum Ratings

Stress above the limits listed in the following table may cause permanent failure. Exposure to absolute ratings for extended time periods may affect device reliability. The limiting values are in accordance with the Absolute Maximum Rating System (IEC 134). All voltages are referenced to ground (GND).

Symbol	Description	Conditions	Min	Max	Unit	
VABS	Voltage applied on any pin		- 0.5	3.9	V	
VESDHBM Electrostatic handling		X+/BR, Y+/TR, X-/TL, Y-/BL, VDD, MVDD	+/-15 <sup>(1)</sup> , +/-8 <sup>(2)</sup>		kV	
	Human Body Model (HBM)	Other pins	+/-	8 <sup>(2)</sup>		
VESDCDM	Electrostatic handling	X+/BR, Y+/TR, X-/TL, Y-/BL, VDD, MVDD	+/	′-1	kV	
	Charged Device Model (CDM)	Other pins	+/-1			
VESDMM	Electrostatic handling	X+/BR, Y+/TR, X-/TL, Y-/BL, VDD, MVDD	+/-2	250	v	
	Machine Model (MM)	Other pins	+/-250			
VESDCD	Electrostatic handling Contact Discharge (CD)	X+/BR, Y+/TR, X-/TL, Y-/BL, VDD, MVDD	+/-	15	kV	
TAMB	Operating ambient temperature		-40	+85	C	
TJUN	Operating junction temperature		-40	+125	C	
TSTOR	Storage temperature		-55	+150	C	
ILAT	Latch-up current <sup>(3)</sup>		+/-	100	mA	

(1) Tested to TLP (10A)

(2) Tested to JEDEC standard JESD22-A114
 (3) Tested to JEDEC standard JESD78

#### Table 2 - Absolute Maximum Ratings

#### 2.2 Thermal Characteristics

Symbol	Description	Conditions	Min	Max	Unit
θJAQ	Thermal Resistance Junction – Ambient QFN package	-	-	30.5	°C/W
θJAW Thermal Resistance Junction – Ambient WLCSP package		-	-	29	°C/W

Table 3 – Thermal Characteristics

#### 2.3 Electrical Specifications

Table below applies to full supply voltage and temperature range, unless otherwise specified. Typical values are given for  $T_A = +25$  °C, VDD=VDDM=3.3V.

Symbol	Description	Conditions	Min	Тур.	Max	Unit
Supply		· · ·				
VDD	Main supply voltage	-	2.3	-	3.6	V
IDD	Main supply current	OFF (MAN mode, no command, HAPT OFF)	-	0.4	0.75	uA
		WAIT (PENDET/TRG mode, pen up, PROX OFF, HAPT OFF)	-	1.7	-	
		TOUCH1 (PENTRG mode, pen down, X+Y, RATE=4kcps, Nfilt=1, POWDLY=0.5us, touchscreen current excluded, HAPT OFF, VDD=2.3V)	-	30	-	
		TOUCH2 (PENTRG mode, pen down, X+Y, RATE=3kcps, Nfilt=7, POWDLY=0.5us, touchscreen current excluded, HAPT OFF)	-	120	160	



Haptics Enabled Multitouch 4/5-Wire Resistive Touchscreen Controller with Proximity Sensing

## ADVANCED COMMUNICATIONS & SENSING

Symbol	Description	Conditions	Min	Тур.	Max	Unit
		PROX (PENDET/TRG mode, pen up, TOUCHRATE=80cps, PROX ON, SCANPERIOD=200ms, HIGHIM=ON, SENSITIVITY=Max, FREQ=150kHz, BOOST=OFF, HAPT OFF)	-	8	20	
		HAPT (MAN mode, no command, LRA-PWM mode, MIN= 44.8kHz/50%, GAIN = Max, BW = 100, MOUTP/N floating, Squelch=011)	-	115	145	
MVDD	Haptics supply voltage	-	VDD	-	3.6	V
		OFF	-	0.01	1	μA
MIDD	Haptics supply current	SQUELCH (LRA-PWM mode, MIN= 44.8kHz/50%, GAIN = Max, BW = 100, MOUTP/N floating, Squelch=011)	-	6	10	μΑ
Digital I/0	Os (ADDR, SCL, SDA, NRST, NIRO		)			
VIH	High level input voltage	SCL, SDA, NRST	0.8*VDD	-	3.6	V
		Other pins	0.8*VDD	-	VDD+0.2	2
VIL	Low level input voltage	-	-0.3	-	0.8	V
ILEAK	Input leakage current	-	-1	-	1	μA
CI VOH	Input capacitance	- IOH = 4mA	- 0.0*\/DD	5	-	pF V
VOH	High level output voltage Low level output voltage	IOH = 4MA IOL = 4mA	0.8*VDD -	-	- 0.4	V
VPULL	External pull-up voltage	SCL, SDA, NRST, NIRQ	-	-	3.6	V
Haptics I		SOE, SDA, NHST, NHQ	-	-	5.0	V
•	Maximum drive current					
IDRV	(MOUTP/MOUTN)	MVDD = 3.6V	-	250	-	mA
VOFF	Output squelch differential error (from 0V ideal)	LRA or ERM, PWM or I2C, AmplitudeCode within squelch range, GAIN = Max, BW = 100, MOUTP/N floating, Squelch=011	0 <sup>(1)</sup>	0	0 <sup>(1)</sup>	mV
VERR	Output differential error (from 1.135V ideal)	LRA or ERM, I2C, AmplitudeCode = +127 (Max) GAIN = Min, BW = 100, MOUTP/N floating	125 <sup>(2)</sup>	0	125 <sup>(2)</sup>	mV
VDRV	Drive voltage (MOUTP/MOUTN)	-	-	-	VDDM	V
VDROP	Drop voltage (MOUTP/MOUTN)	From MVDD/MGND, @250mA	-	-	150	mV
ISHORT	Short-circuit detection current	Measured @MIDD	-	300	-	mΑ
FMINC	Motor input (MIN) frequency in I2C mode	40-60% duty cycle	-	-	50	MHz
	Motor input (MIN) frequency in	HAPTRANGE = 0	12.8	-	25.6	kHz
FMINP	PWM mode	HAPTRANGE = 1	25.6	-	51.2	kHz
DCMIN	Motor input (MIN) duty cycle in PWM mode		2	-	98	%
TWRNG	Warning temperature	Junction temperature	-	120	-	ĉ
TALRM	Alarm temperature	Sunction temperature	-	155	-	C
	reen Interface					
ARES	ADC resolution		12	-	-	bits
AOFF	ADC offset		-	±1	-	4
AGE	ADC gain error	At full scale	-	0.5	-	LSB
ADNL	ADC differential non-linearity		-	±1	-	- 1
AINL RBIAS	ADC integral non-linearity Biasing resistance		-	± 1.5 5	-	Ω
Proximity		<u> </u>	-	5		12
CDC	External capacitance to be compensated	-	-	-	300	pF
t <sub>PROX</sub>	Scan period (reaction time)	Programmable	_	200		ms
PROX		i i ogrammable	l	200	1	113



Haptics Enabled Multitouch 4/5-Wire Resistive Touchscreen Controller with Proximity Sensing

## **ADVANCED COMMUNICATIONS & SENSING**

Symbol	Description	Conditions	Min	Тур.	Max	Unit
Reset						
VPOR	Power-On-Reset voltage	Cf. §10	-	1.3	-	V
t <sub>RESET</sub>	Reset time after POR	Cf. §10	-	-	1	ms
t <sub>PULSE</sub>	Reset pulse from host uC	Cf. §10	1	-	-	us
I2C Interf	ace					
	DA t <sub>r</sub> t <sub>r</sub> t <sub>LOW</sub> t <sub>r</sub> t <sub>r</sub> t <sub>SU:DAT</sub> CL S	t <sub>f</sub>	tsu;sto-		s	
f <sub>SCL</sub>	SCL clock frequency	-	-	-	400	kHz
t <sub>HD;STA</sub>	Hold time (repeated) START condition	-	0.6	-	-	μs
t <sub>LOW</sub>	LOW period of the SCL clock	-	1.3	-	-	μs
t <sub>HIGH</sub>	HIGH period of the SCL clock	-	0.6	-	-	μs
t <sub>SU;STA</sub>	Set-up time for a repeated START condition	-	0.6	-	-	μs
t <sub>HD:DAT</sub>	Data hold time	-	0	-	-	μs
t <sub>SU:DAT</sub>	Data set-up time	-	100	-	-	ns
t <sub>r</sub>	Rise time of both SDA and SCL	-	20+0.1Cb	-	300	ns
t <sub>f</sub>	Fall time of both SDA and SCL	-	20+0.1Cb	-	300	ns
t <sub>su:sto</sub>	Set-up time for STOP condition	-	0.6	-	-	μs
t <sub>BUF</sub>	Bus free time between a STOP and START condition	-	1.3	-	-	μs
Cb	Capacitive load for each bus line	-	-	-	400	pF
t <sub>SP</sub>	Pulse width of spikes suppressed by the input filter	Up to 0.3xVDD from GND, down to 0.7xVDD from VDD	50	-	-	ns
Miscellan						
FOSCL	Low frequency internal oscillator	-	-	32	-	kHz
FOSCH	High frequency internal oscillator	-	-	1.8	-	MHz

<sup>(1)</sup> Guaranteed by design.
 <sup>(2)</sup> PWM mode can introduce an additional error of 2.5% of full scale.

Table 4 – Electrical Specifications

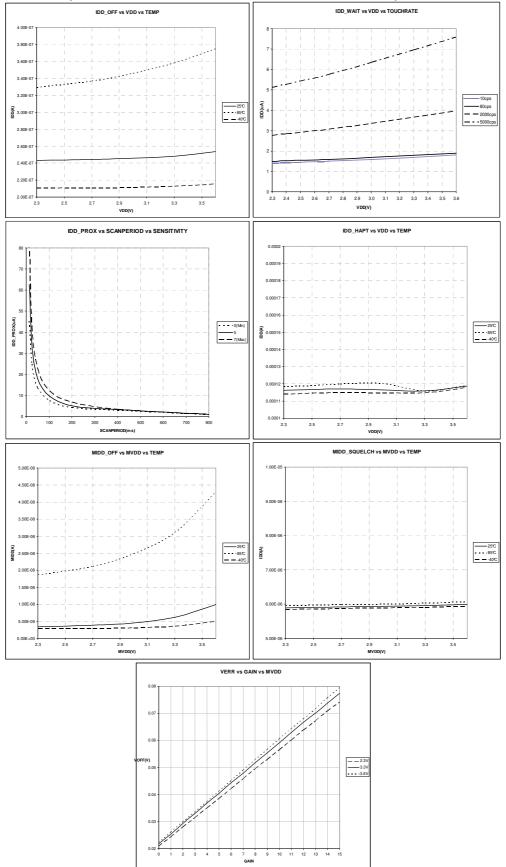


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### **3 TYPICAL OPERATING CHARACTERISTICS**

Conditions as defined in §2.3, T<sub>A</sub> = +25°C, VDD=VDDM=3.3V unless otherwise specified.





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#### 4 TOUCHSCREEN INTERFACE

#### 4.1 Introduction

The purpose of the touchscreen interface is to measure and extract touch information like coordinates and pressure. This is done in two steps, first an ADC measures the analog signal coming from the screen, and then digital processing is performed to consolidate the data.

As illustrated below the chip's touchscreen interface is compatible with both 4-wire and 5-wire touchscreens. Touchscreen type is defined by parameter TSTYPE.

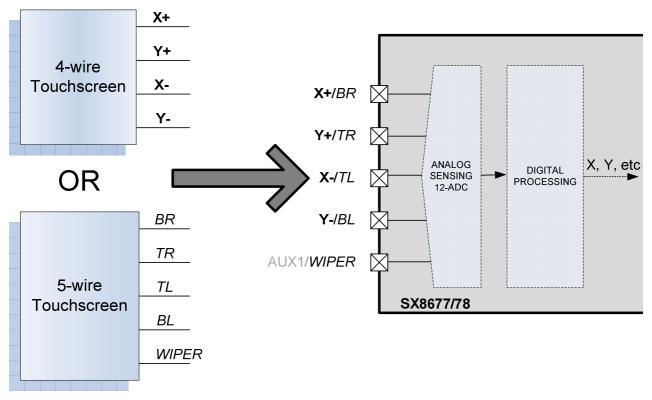


Figure 7 – Touchscreen Interface Overview

A 4-wire resistive touch screen consists in two (resistive) conductive sheets separated by an insulator when not pressed. Each sheet is connected through 2 electrodes at the border of the sheet. When a pressure is applied on the top sheet, a connection with the lower sheet is established.

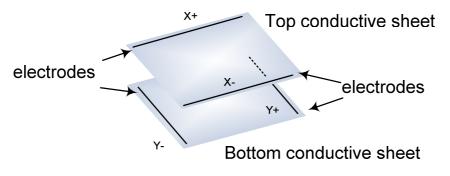


Figure 8 – 4-wire Touchscreen

A 5-wire resistive touch screen consists in two (resistive) conductive sheets separated by an insulator when not pressed. 4 electrodes are connected on the 4 corners of the bottom conductive sheet. They are referred as Top Left (TL), Top Right (TR), Bottom Left (BL) and Bottom Right (BR).

The fifth wire (WIPER) is used for sensing the top sheet voltage. When a pressure is applied on the top sheet, a connection with the lower sheet is established.



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Higher reliability and better endurance are the advantages of 5-wire touchscreens but they do not allow pressure measurement

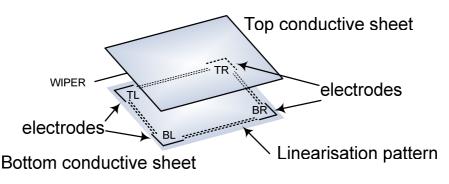


Figure 9 – 5-wire Touchscreen

#### 4.2 Coordinates Measurement

#### 4.2.1 4-wire Touchscreen

The electrode plates are internally connected through terminals  $X_+$ ,  $X_-$  and  $Y_+$ ,  $Y_-$  to an analog to digital converter (ADC) and a reference voltage (Vref). The resistance between the terminals  $X_+$  and  $X_-$  is defined by Rxtot. Rxtot will be split in 2 resistors, R1 and R2, in case the screen is touched. Similarly, the resistance between the terminals  $Y_+$  and  $Y_-$  is represented by R3 and R4. The connection between the top and bottom sheet is represented by the touch resistance (RT).

In order to measure the Y coordinate, the top resistive sheet (Y) is biased with a voltage source (Vref). Resistors R3 and R4 determine a voltage divider proportional to the Y position of the contact point. Since the converter has a high input impedance, no current flows through R1 (and RT) so that the voltage X+ at the converter input is given by the voltage divider created by R3 and R4.

The X coordinate is measured in a similar fashion with the bottom resistive sheet (X) biased to create a voltage divider by R1 and R2, while the voltage on the top sheet is measured through R3.

The resistance RT is the resistance obtained when a pressure is applied on the screen. RT is created by the contact area of the X and Y resistive sheet and varies with the applied pressure.

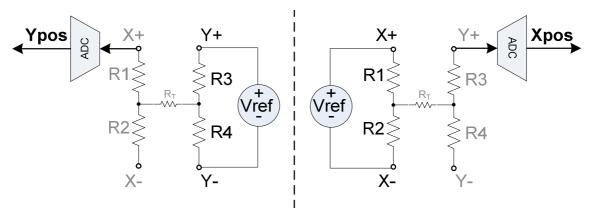


Figure 10 – 4-wire Touchscreen Coordinates Measurement

The X and Y positions output by the ADC correspond to the formulas below:  $X_{pos} = 4095 \cdot \frac{R2}{R1+R2}$   $Y_{pos} = 4095 \cdot \frac{R4}{R3+R4}$ 

4095 corresponds to the max output value of the ADC (12 bits =>  $2^{12} - 1$ ).

For example, a touch in the center of the screen will output (Xpos, Ypos) = ~(2048, 2048)



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#### 4.2.2 5-wire Touchscreen

5-wire touchscreen coordinates measurement is performed similarly by biasing opposite corner pairs in either X or Y directions on the lower panel, and converting the voltage appearing on the wiper panel with the ADC.

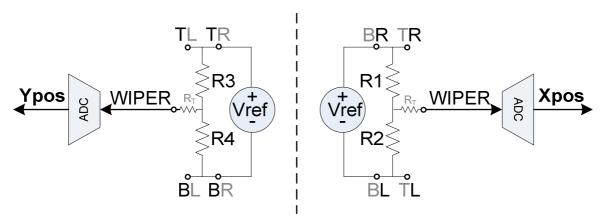


Figure 11 – 5-wire Touchscreen Coordinates Measurement

The X and Y positions output by the ADC correspond to the formulas below:

$$Xpos = 4095 \cdot \frac{R2}{R1 + R2}$$
  $Ypos = 4095 \cdot \frac{R4}{R3 + R4}$ 

4095 corresponds to the max output value of the ADC (12 bits =>  $2^{12} - 1$ ).

For example, a touch in the center of the screen will output (Xpos, Ypos) = ~(2048, 2048)

#### 4.3 Pressure Measurement (4-wire only)

The pressure measurement consists in extracting the touch resistance  $R_T$  via two additional setups z1 and z2 illustrated below. The smaller  $R_T$ , the more common touched surface there is between top and bottom plates and hence the more "pressure" there is by the user.

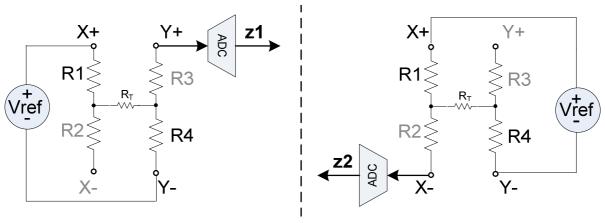


Figure 12 – Pressure Measurement

The z1 and z2 values output by the ADC correspond to the formulas below:  $z1 = 4095 \cdot \frac{R4}{R1 + R4 + R_T}$   $z2 = 4095 \cdot \frac{R4 + Rt}{R1 + R4 + R_T}$ 

The X and Y total sheet resistance (Rxtot = R1+R2, Rytot = R3+R4) are known from the touch screen supplier.

R4 is proportional to the Y coordinate and its value is given by the total Y plate resistance Rytot multiplied by the fraction of the Y position over the full coordinate range.



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$$Rxtot = R1 + R2$$
$$Rytot = R3 + R4$$
$$R4 = Rytot \cdot \frac{Ypos}{4095}$$

Re-arranging z1 and z2 gives:

$$R_{\rm T} = R4 \cdot \left[\frac{z2}{z1} - 1\right]$$

This finally results in:

$$R_{T} = Rytot \cdot \frac{Ypos}{4095} \cdot \left[\frac{z2}{z1} - 1\right]$$

The touch resistance calculation above hence requires three channel measurements (Ypos, z2 and z1) and one specification data (Rytot).

An alternative calculation method is using Xpos, Ypos, one z channel and both Rxtot and Rytot as shown in the next calculations.

R1 is inversely proportional to the X coordinate:

$$R1 = Rxtot \cdot \left[1 - \frac{Xpos}{4095}\right]$$

Substituting R1 and R4 into z1 and rearranging terms gives:

$$R_{T} = \frac{Rytot \cdot Ypos}{4095} \cdot \left[\frac{4095}{z1} - 1\right] - Rxtot \cdot \left[1 - \frac{Xpos}{4095}\right]$$

Please note that the chip only outputs z1, z2, etc. The calculation of  $R_T$  itself with the formulas above must be performed by the host.

#### 4.3.1 Bias Time (POWDLY)

In order to perform correct measurements, some time must be given for the touch screen to reach a proper Vref bias level before the conversion is actually performed. It is a function of the PCB trace resistance connecting the chip to the touchscreen and also the capacitance of the touchscreen. If tau is this RC time constant, then POWDLY duration must be programmed to 10 tau to reach 12 bits accuracy.

Adding a capacitor from the touch screen electrodes to ground may also be used to minimize external noise (if the touchscreen is used as the proximity sensor, make sure you do not exceed the maximum capacitive load for required for proper proximity sensing operation). The low-pass filter created with the capacitor may increase settling time requirement. Therefore, POWDLY can be used to stretch the acquisition period and delay conversion appropriately.

POWDLY can be estimated by the following formula:

$$PowDly = 10 \times Rtouch \times Ctouch$$

#### 4.4 Pen Detection

The pen detection circuitry is used both to detect a user action and generate an interrupt or start an acquisition in PENDET and PENTRG mode respectively. Doing pen detection prior to conversion avoids feeding the host with dummy data and saves power. Pen detection is also used to disable and resume proximity sensing. For more details on pen detection usage please refer to §4.7.

A 4-wire touchscreen will be powered between X+ and Y- through a resistor RPNDT so no current will flow as long as no pressure is applied to the surface (see figure below). When a touch occurs, a current path is created bringing X+ to the level defined by the resistive divider determined by RPNDT and the sum of R1, RT and R4.



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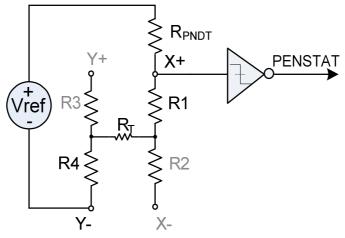


Figure 13 – 4-wire Touchscreen Pen Detection

When using a 5-wire touchscreen, the pen detection pull-up resistor  $R_{PNDT}$  and digital comparator continue to monitor the X+/BR pin as in 4-wire mode. The top panel is grounded via the WIPER pin to provide the grounding path for a screen touch event. When a touch occurs, a current path is created and will bring BR to the level defined by the resistive divider determined by  $R_{PNDT}$  and the sum of R1, RT and RW.

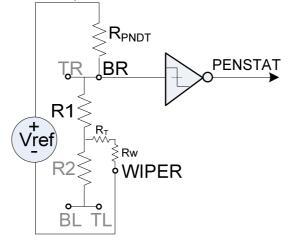


Figure 14 – 5-wire Touchscreen Pen Detection

 $R_{PNDT}$  can be configured to 4 different values to accommodate different screen resistive values.  $R_{PNDT}$  should be set to a value greater than 7x(Rxtot + Rytot), it is recommended to set it to max value.

Pen detection uses a bias time of POWDLY/8 (digital comparator => less precision required vs analog conversion). Increasing POWDLY can improve the detection on panels with high resistance.

A pen touch will set the PENSTAT bit of the RegStat register which will generate an interrupt if enabled in RegIrqMsk.

A pen release will reset PENSTAT bit of the RegStat register which will generate an interrupt if enabled in RegIrqMsk.

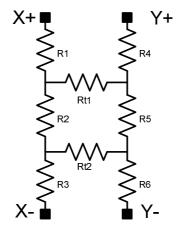
#### 4.5 Multitouch Measurement (4-wire only)

SX8677/78 support up to two simultaneous touches on any standard 4-wire touchscreen. The simplified model for dual-touch is given in figure below.



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Rxtot = R1 + R2 + R3 Rytot = R4 + R5 + R6Figure 15 – Dual-touch Simplified Model

The two contacts create touch resistances Rt1 and Rt2 between the two layers of the touchscreen.

The SX8677/78 perform on-chip specific multitouch measurements which the host retrieves and processes with a specific software enabling the detection of the gestures described in §13.3.

For optimum gesture detection, RmSelX and RmSelY parameters should be set according to table below.

X/Y Panel Resistance (Ω)	RmSelX/Y
100-187	000
188-312	001
313-938	010
939-1875	011
1876-4375	100
4376-9375	101
9376-18780	110
>18780	111
T	

Table 5 – RmSelX/Y Selection Table

#### 4.6 Digital Processing

The chip offers 4 types of data processing which allows the user to make trade-offs between data throughput, power consumption and noise rejection.

The parameter FILT is used to select the filter order Nfilt. The noise rejection will be improved with a high order to the detriment of power consumption. Each channel can be sampled up to 7 times and then processed to get a single consolidated coordinate.

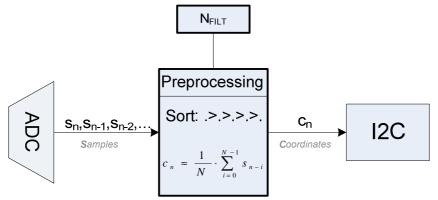


Figure 16 – Digital Processing Block Diagram



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FILT	Nfilt	Function			
0	1	$c_n = s_n$			
Ŭ	1	No average.			
1	3	$c_n = \frac{1}{3} \cdot \frac{4079}{4095} (s_n + s_{n-1} + s_{n-2})$			
		3 ADC samples are averaged.			
2	5	$c_n = \frac{1}{5} \cdot \frac{4079}{4095} (s_n + s_{n-1} + s_{n-2} + s_{n-3} + s_{n-4})$			
		5 ADC samples are averaged.			
		$s_{\max 1} \ge s_{\max 2} \ge s_a \ge s_b \ge s_c \ge s_{\min 1} \ge s_{\min 2}$			
3	7	$c_n = \frac{1}{3} \cdot \frac{4079}{4095} (s_a + s_b + s_c)$			
		7 ADC samples are sorted and the 3 center samples are averaged.			
	Table 6 – Digital Processing Functions				

The parameter SETDLY sets the settling time between the consecutive conversions of the same channel.

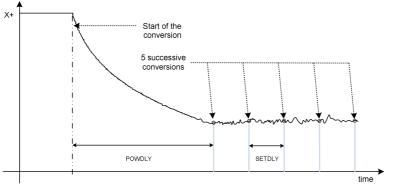


Figure 17 – POWDLY and SETDLY (FILT=2)

In most applications, SETDLY can be set to minimum (0.5us). However, in some particular applications where an accuracy of 1LSB is required SETDLY may need to be increased.

#### 4.7 Host Operation

#### 4.7.1 Overview

The chip has three operating modes that are configured using the I2C as defined in §11 :

- ➤ Manual (command 'MAN' and TOUCHRATE = 0).
- Pen detect (command 'PENDET' and TOUCHRATE > 0).
- Pen trigger (command 'PENTRG' and TOUCHRATE > 0).

At power-up the chip is set in manual mode.

#### 4.7.2 Manual Mode (MAN)

In manual mode (MAN) the touchscreen interface is stopped and conversions must be manually triggered by the host using SELECT and CONVERT command.



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When a command is received, the chip executes the associated tasks listed in table below and waits for the next command. It is up to the host to sequence all actions.

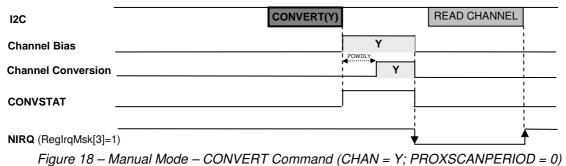
Pen detection is performed after each CONVERT command and if pen is not detected, no touch operation is performed. Following figures assume pen down. PENSTAT is not updated in MAN mode.

To enter MAN mode the host must send the MAN command and then set TOUCHRATE = 0.

Command	Actions
CONVERT(CHAN)	Select and bias CHAN Wait for the programmed settling time (POWDLY) Convert CHAN
SELECT(CHAN)	Select and bias CHAN

Table 7 – Manual Mode Commands

As illustrated in figure below the CONVERT command will bias the channel, wait for the programmed settling time (POWDLY), and run the conversion.



When the CONVERT command is used with CHAN=SEQ, multiple channels as defined in RegChnMsk are sampled. In this case, each channel will be sequentially biased during POWDLY before a conversion is started. At the end of each channel conversion the bias is automatically removed.

12C	CONVERT(SEQ)				READ CHANNEL	
Channel Bias		X POWDLY.	POWDLY			   
Channel Conversion		X	Y			
CONVSTAT						
NIRQ (ReglrqMsk[3]=1	)		•	7		]

In case the range of POWDLY settings available is not enough to cover the required settling time, one can use the SELECT command first to bias the channel, and then send the CONVERT command hence extending bias time. SELECT command cannot be used with CHAN=SEQ.

I2C	SELECT(Y)	CONVERT(Y)		READ CHANNEL
Channel Bias		Y		
Channel Conversion		Actual bias time	Y	
CONVSTAT				
NIRQ (ReglrqMsk[3]=1	)			

Figure 19 – Manual Mode – CONVERT Command (CHAN = SEQ = [X;Y]; PROXSCANPERIOD = 0)



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### Figure 20 – Manual Mode – SELECT command (CHAN = Y; PROXSCANPERIOD = 0)

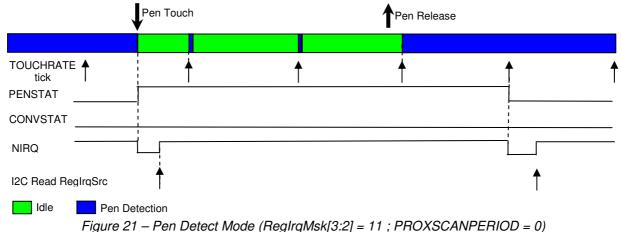
At the end of the conversion(s) bit CONVSTAT will be reset which will trigger NIRQ falling edge (if enabled in RegIrqMsk). Host can then read channel data which will release NIRQ.

Please note that when the SELECT command is used, the channel is converted whatever the pen status (no pen detection performed).

#### 4.7.3 Pen Detect Mode (PENDET)

In pen detect mode (PENDET) the chip will only run pen detection (continuously when pen is up, regularly as defined by TOUCHRATE when pen is down) and update PENSTAT bit in RegStat to be able to generate an interrupt (NIRQ) upon pen detection and/or release. No (touch) conversion is performed in this mode.

To enter PENDET mode the host must set TOUCHRATE > 0 and then send PENDET command. To quit PENDET mode and stop the touchscreen interface the host must enter MAN mode.



Please note that the next pen detection is not performed as long as NIRQ is low. If the host is too slow and doesn't read IrqSrc before next TOUCHRATE tick, no operation is performed and this TOUCHRATE tick is simply ignored until next one.

#### <u>4.7.4</u> Pen Trigger Mode (PENTRG)

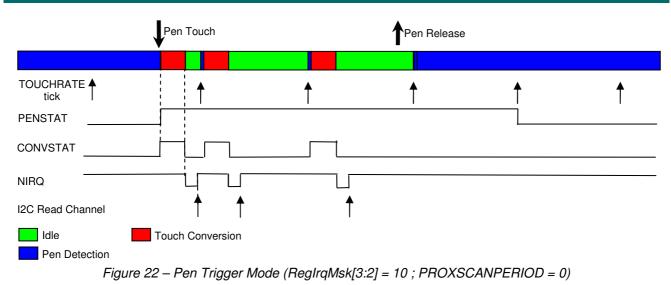
In pen trigger mode (PENTRG) the chip will perform pen detection (continuously when pen is up, regularly as defined by TOUCHRATE when pen is down) and if pen is down, will be followed by a conversion as defined in RegChanMsk. The chip will update CONVSTAT bit in RegStat and will be able to generate an interrupt (NIRQ) upon conversion completion. The chip will also update PENSTAT bit in RegStat and will be able to generate an interrupt (NIRQ) upon pen detection and/or release.

The PENTRG mode offers the best compromise between power consumption and coordinate throughput. To enter PENTRG mode the host must set TOUCHRATE > 0 and then send PENTRG command. To quit PENTRG mode and stop the touchscreen interface the host must enter MAN mode.



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Please note that to prevent data loss, the next pen detection and conversion are not performed as long as all current channel data (i.e. channels selected in RegChanMsk) have not been read. If the host is too slow and doesn't read all channel data before next TOUCHRATE tick, no operation is performed and this TOUCHRATE tick is simply ignored until next one.

### 4.7.5 Maximum Throughput vs. TOUCHRATE setting

In PENTRG mode the TOUCHRATE parameter is used to define the required coordinate's throughput/rate. However, as previously mentioned, in order for a new conversion to be performed the current conversion must be completed and all relevant channel data must have been read by the host. If this condition is not met when the next TOUCHRATE tick occurs, the tick is ignored and the condition checked again at the next one. This will result in reduced actual rate vs what has been programmed in the TOUCHRATE parameter.

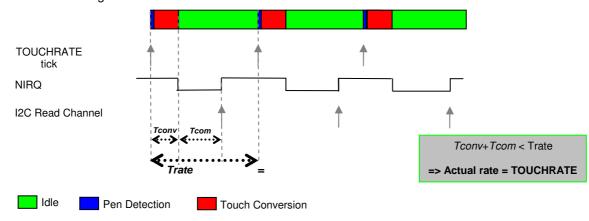


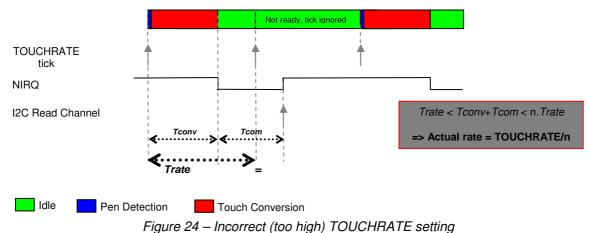
Figure 23 – Correct TOUCHRATE setting

This is illustrated in figures below.



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In order to prevent this, one can estimate the maximum throughput achievable and set TOUCHRATE parameter accordingly.

#### MaxThroughput = 1 / (Tconv+Tcom)

Tcom is the time between the end of conversion (ie NIRQ falling edge) and the end of channel data reading (i.e. NIRQ rising edge). Maximum throughput implies that the host reacts "instantaneously" to NIRQ falling edge:

$$T_{com} \cong (8 + 16 \times N_{chan}) \times T_{I2C}$$

Tconv is the total conversion time:

$$Tconv(us) = 47 \cdot Tosc + N_{chan} \cdot (POWDLY + (N_{filt} - 1) \cdot SETDLY + (21N_{filt} + 1) \cdot Tosc)$$

- $T_{I2C}$  is the period of the I2C clock SCL
- $N_{filt} = \{1,3,5,7\}$  based on the order defined for the filter FILT
- $N_{chan} = \{1, 2, 3, 4, 5\}$  based on the number of channels defined in RegChanMsk
- POWDLY = 0.5us to 18.19ms, settling time as defined in RegTS0
- SETDLY = 0.5us to 18.19ms, settling time when filtering as defined in RegTS2
- Tosc is the period of the internal oscillator FOSCH

Some examples of maximum throughputs achievable with an I2C running at 400kHz are given below.

Nchan	Nfilt	POWDLY [us]	SETDLY [us]	Tconv [us]	Tcom [us]	Total [us]	CR [kcps]	ECR [kcps]	SR [ksps]	ESR [ksps]
2	1	0.5	0.5	51.7	100	151.7	6.6	13.2	6.6	13.2
2	3	35.5	0.5	170.6	100	270.6	3.7	7.4	11.1	22.2
2	5	2.2	0.5	152.8	100	252.8	4	8	20	40
4	3	35.5	0.5	315.0	200	515	1.9	7.6	5.7	22.8

Table 8 – Maximum Throughputs Examples

- CR = Coordinate Rate

- ECR = Equivalent Coordinate Rate = CR x N<sub>chan</sub>

- SR = Sampling Rate = CR x N<sub>filt</sub>

- ESR = Equivalent Sampling Rate = SR x  $N_{chan}$  = CR x  $N_{filt}$  x  $N_{chan}$ 

For proper operation, the TOUCHRATE parameter should not exceed the theoretical maximum throughput CR.



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#### 5 **PROXIMITY SENSING INTERFACE (SX8677)**

#### 5.1 Introduction

The purpose of the proximity sensing interface is to detect when a conductive object (usually a body part i.e. finger, palm, face, etc) is in the proximity of the system. This is commonly used in power-sensitive mobile applications to turn the screen's LCD ON/OFF depending on user's finger/palm/face proximity.

The chip's proximity sensing interface is based on capacitive sensing technology and shares the ADC with the touchscreen interface (Cf §5.4.2). An overview is given in figure below.

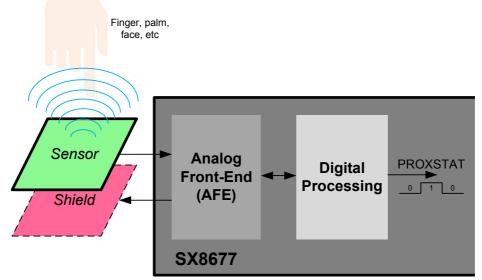


Figure 25 – Proximity Sensing Interface Overview

- The sensor can be the top layer of the touchscreen or a simple copper area on the PCB (programmable in PROXSENSORCON). Its capacitance (to ground) will vary when a conductive object is moving in its proximity.
- The optional shield can be the bottom layer of the touchscreen or a simple copper area on the PCB (programmable in PROXSHIELDCON) below/under/around the sensor. It is used to protect the sensor against potential surrounding noise sources and improve its global performance. It also brings directivity to the sensing, for example sensing objects approaching from top only.
- The analog front-end (AFE) performs the raw sensor's capacitance measurement and converts it into a 12 bit digital code. It also controls the shield. See §5.2 for more details.
- The digital processing block computes the raw capacitance measurement from the AFE and extracts a binary information PROXSTAT corresponding to the proximity status, i.e. object is "Far" or "Close". It also triggers AFE operations (compensation, etc). See §5.3 for more details.

To save power since the proximity event is slow by nature, the block will be waken-up regularly at every programmed scan period (PROXSCANPERIOD) to sense and then process a new proximity sample. The block will be in idle mode most of the time. This is illustrated in figure below

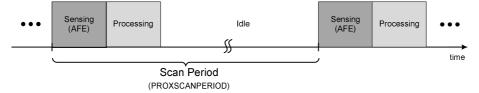


Figure 26 – Proximity Sensing Sequencing



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#### 5.2 Analog Front-End (AFE)

#### 5.2.1 Capacitive Sensing Basics

Capacitive sensing is the art of measuring a small variation of capacitance in a noisy environment. As mentioned above, the chip's proximity sensing interface is based on capacitive sensing technology. In order to illustrate some of the user choices and compromises required when using this technology it is useful to understand its basic principles.

To illustrate the principle of capacitive sensing we will use the simplest implementation where the sensor is a copper plate on a PCB but the exact same principles apply if the sensor is the touchscreen's top plate.

The figure below shows a cross-section and top view of a typical capacitive sensing implementation. The sensor connected to the chip is a simple copper area on top layer of the PCB. It is usually surrounded (shielded) by ground for noise immunity (shield function) but also indirectly couples via the grounds areas of the rest of the system (PCB ground traces/planes, housing, etc). For obvious reasons (design, isolation, robustness ...) the sensor is stacked behind an overlay which is usually integrated in the housing of the complete system. When the touchscreen is used for sensing the overlay corresponds to the thin and flexible protection film covering the top panel.

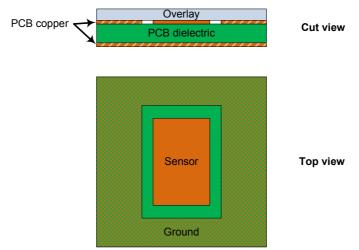


Figure 27 – Typical Capacitive Sensing Implementation

When the conductive object to be detected (finger/palm/face, etc) is not present, the sensor only sees an inherent capacitance value  $C_{Env}$  created by its electrical field's interaction with the environment, in particular with ground areas.

When the conductive object (finger/palm/face, etc) approaches, the electrical field around the sensor will be modified and the total capacitance seen by the sensor increased by the user capacitance  $C_{User}$ . This phenomenon is illustrated in the figure below.

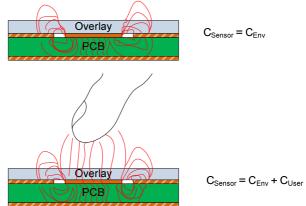


Figure 28 – Proximity Effect on Electrical Field and Sensor Capacitance

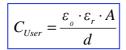


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The challenge of capacitive sensing is to detect this relatively small variation of  $C_{Sensor}$  ( $C_{User}$  usually contributes for a few percents only) and differentiate it from environmental noise ( $C_{Env}$  also slowly varies together with the environment characteristics like temperature, etc). For this purpose, the chip integrates an auto offset compensation mechanism which dynamically monitors and removes the  $C_{Env}$  component to extract and process  $C_{User}$  only. See §5.2.5 for more details.

In first order, C<sub>User</sub> can be estimated by the formula below:



A is the common area between the two electrodes hence the common area between the user's finger/palm/face and the sensor.

*d* is the distance between the two electrodes hence the proximity distance between the user and the system.

 $\varepsilon_{a}$  is the free space permittivity and is equal to 8.85 10e-12 F/m (constant)

 $\mathcal{E}_r$  is the dielectric relative permittivity.

When performing proximity sensing the dielectric relative permittivity is roughly equal to that of the air as the overlay is relatively thin compared to the detection distance targeted. Typical permittivity of some common materials is given in the table below.

Material	<b>Typical</b> $\varepsilon_r$		
Glass	8		
FR4	5		
Acrylic Glass	3		
Wood	2		
Air	1		

From the discussions above we can conclude that the most robust and efficient design will be the one that minimizes  $C_{Env}$  value and variations while improving  $C_{User}$ .

#### 5.2.2 AFE Block Diagram

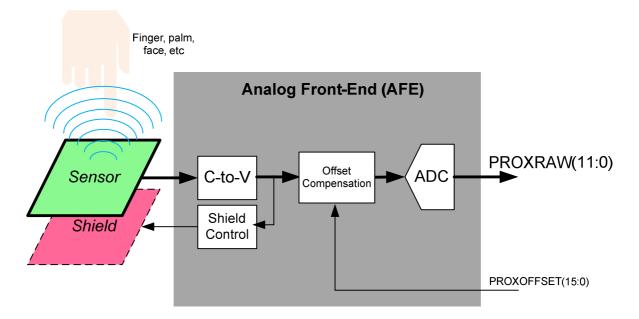


Figure 29 – Analog Front-End Block Diagram